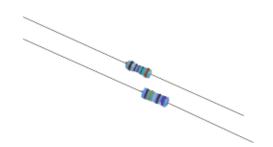
Features:

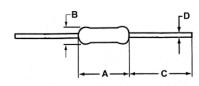
- · Precision metal film
- Superior electrical, TCR performances
- Flame-retardant coatings are standard
- Panasert available selected sizes (contact Stackpole)
- RNMF (mini) an ideal choice where size constraints apply
- RNF 5% replaces MP series
- Lower or higher resistance values may be possible (contact Stackpole)
- 100% RoHS compliant and lead free without exemption
- Halogen free
- REACH compliant



Electrical Specifications												
Type / Code	Mil Ref	Power Rating (W)	Maximum Working Voltage	Maximum Overload Voltage	TCR (ppm/°C)	Ohmic Range (Ω) and Tolerance						
		@ 70°C	(Vrms) (1)	(Vrms)		0.05%	0.1%	0.25%	0.5%	1%	2%	5%
					± 25		100 - 100K			49.9 - 499K		_
RNF18	RN 50	0.125	200	400	± 50	100 - 100K		100 - 100K	10 - 1M	1 - 1M		
					± 100		51.1 - 100K		-	1 - 10M	1 -	22M
					± 25				30.1 - 499K	30.1 - 499K		-
RNMF14	-	0.25	200	400	± 50	-	100 -	100K	10 - 1M	1 - 1M		
					± 100		100 1001	Ī	_	1 - 2.15M	1 -	2.2M
					± 10		100 - 100K		-	40.414		-
RNF14	RN 55	0.25 250	250	250 500	± 25	100 - 100K	1 - 2.2M			10 - 1M	-	4.4144014
					± 50 ± 100					1 - 5.11M 1 - 10M	5.6 - 10M	1.1M - 10M 1 - 10M
					± 100		30.1 -	201K	49.9		3.0 - TOW	1 - 10101
RNMF12	RL 07	0.5	350	600	± 50	_				1 - 1M		-
		0.0	000		± 100		30.1 - 1M		10 - 1M	1 - 10M	1 -	10M
					± 25				49.9 -	499K	·	
RNF12	RN 60	0.5	350	700	± 50		100 - 100K			1 - 4.99M		-
					± 100				10 - 1M	1 - 10M	1 -	10M
					± 25							-
RNF1	RN 65	1	350	700	± 50		-		10 - 1M	10 - 470K	-	10 - 470K
					± 100			TO - TIVI	1 - 1M		1 - 1M	
					± 25					-		_
RNF2	-	2	2 350	800 ±	± 50		-	•		10 - 1M	-	
(4) 1					± 100							10 - 1M

(1) Lesser of √P*R or maximum working voltage

Mechanical Specifications



Type / Code	A	В	С	D	Unit
Type / Code	Body Length	Body Diameter	Lead Length (Bulk)	Lead Diameter	Offic
RNF18	0.130 ± 0.012	0.071 ± 0.012	1.102 ± 0.118	0.018 ± 0.003	inches
KINF 10	3.30 ± 0.30	1.80 ± 0.30	28.00 ± 3.00	0.45 ± 0.07	mm
RNMF14	0.130 ± 0.012	0.070 ± 0.003	1.102 ± 0.118	0.017 ± 0.002	inches
KINWII 14	3.30 ± 0.30	1.78 ± 0.08	28.00 ± 3.00	0.44 ± 0.05	mm
RNF14	0.250 ± 0.026	0.093 ± 0.010	1.102 ± 0.118	0.022 ± 0.003	inches
10101 14	6.35 ± 0.65	2.35 ± 0.25	28.00 ± 3.00	0.56 ± 0.08	mm
RNMF12	0.250 ± 0.026	0.093 ± 0.010	1.102 ± 0.118	0.022 ± 0.003	inches
INIVII 12	6.35 ± 0.65	2.35 ± 0.25	28.00 ± 3.00	0.56 ± 0.08	mm
RNF12	0.344 ± 0.030	0.108 ± 0.039	1.102 ± 0.197	0.026 ± 0.004	inches
IXINI 12	8.75 ± 0.75	2.75 ± 1.00	28.00 ± 5.00	0.65 ± 0.10	mm

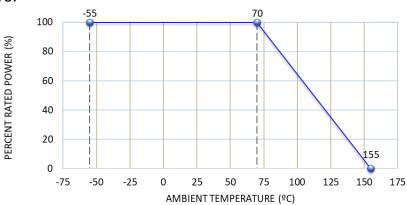
1

Mechanical Specifications (cont.)							
Type / Code	Α	В	С	D	Unit		
Type / Code	Body Length	Body Diameter	Lead Length (Bulk)	Lead Diameter	Offic		
DNE4 (4.400)	0.453 ± 0.039	0.177 ± 0.020	1.378 ± 0.079	0.031 ± 0.001	inches		
RNF1 (< 10Ω)	11.50 ± 1.00	4.50 ± 0.50	35.00 ± 2.00	0.78 ± 0.03	mm		
RNF1 (≥ 10Ω)	0.433 ± 0.039	0.177 ± 0.020	1.181 ± 0.118	0.030 ± 0.002	inches		
	11.00 ± 1.00	4.50 ± 0.50	30.00 ± 3.00	0.75 ± 0.05	mm		
RNF2	0.591 ± 0.039	0.197 ± 0.020	1.339 ± 0.157	0.028 ± 0.004	inches		
NINEZ	15.00 ± 1.00	5.00 ± 0.50	34.00 ± 4.00	0.70 ± 0.10	mm		

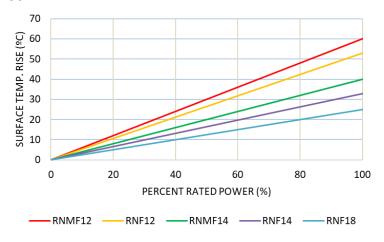
Performance Characteristics						
Test	Test Method	Typical Results	Test Limits			
Insulation Resistance	JIS C5201-1, IEC60115-1, 4.6	≥ 1000M Ω	≥ 1000M Ω			
Voltage Proof / DWV		RNF16 / RNMF14: 300 RNF14 / RNMF12: 500 RNF12 / RNF1: 700	≤ ± (0.5% + 0.05Ω) No mechanical damage			
Short Time Overload	JIS C5201-1, IEC60115-1, 4.13	< ± 0.1%	$\leq \pm (0.25\% + 0.05\Omega)$			
Resistance to Solder Heat	JIS C5201-1, IEC60115-1, 4.18	< ± 0.1%	$\leq \pm (0.3\% + 0.05\Omega)$			
Rapid Change of Temperature	JIS C5201-1, IEC60115-1, 4.19	< ± 0.05%	$\leq \pm (0.35\% + 0.05\Omega)$			
Endurance at 70°C	JIS C5201-1, IEC60115-1, 4.25.1	< ± 0.15%	≤± (1.0% + 0.05Ω)			
Robustness of Terminations	JIS C5201-1, IEC60115-1, 4.16	< ± 0.10%	$\leq \pm (0.2\% + 0.05\Omega)$			
Damp Heat (Steady state)	JIS C5201-1, IEC60115-1, 4.24	< ± 0.10%	$\leq \pm (1.5\% + 0.05\Omega)$			

Operating temperature range is -55°C to +155°C

Power Derating Curve:



Surface Temperature Rise:



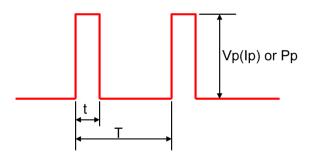
Repetitive Pulse Information:

If repetitive pulses are applied to resistors, pulse wave form must be less than "pulse limiting voltage", "pulse limiting current" or "pulse limiting wattage" calculated by the formula below.

$$Vp = K\sqrt{P \times R \times T/t}$$

$$Ip = K\sqrt{P/R \times T/t}$$

$$Pp = K^2 \times P \times T/t$$



Where: Vp: Pulse limiting voltage (V)

Ip: Pulse limiting current (A)Pp: Pulse limiting wattage (W)

P: Power rating (W)

R: Nominal resistance (ohm)
T: Repetitive period (sec)
t: Pulse duration (sec)

K: RNF / RNMF Coefficient: 0.7

[Vr: Rated Voltage (V), Ir: Rated Current (A)]

Note 1: If T > 10 \rightarrow T = 10 (sec), T / t > 1000 \rightarrow T / t = 1000

Note 2: If T > 10 and T / t > 1000, "Pulse Limiting power (Single pulse) is applied

Note 3: If Vp < Vr (lp < lr or Pp < P), Vr (lr, P) is Vp (lp, Pp)

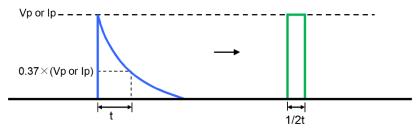
Note 4: Pulse limiting voltage (current, wattage) is applied at less than rated ambient temperature. If ambient temperature is more than the rated temperature (70 °C), decrease power rating according to "Power Derating Curve"

Note 5: Assure sufficient margin for use period and conditions for "pulse limiting voltage"

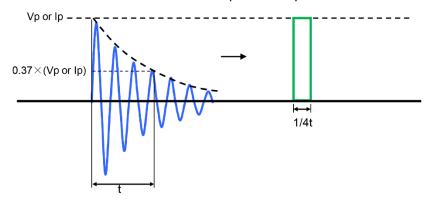
Note 6: If the pulse waveform is not square wave, judge after transform the waveform into square wave according to the "Waveform Transformation to Square Wave".

Waveform Transformation to Square Wave

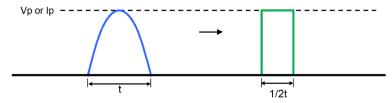
1. Discharge curve wave with time constant "t" → Square wave



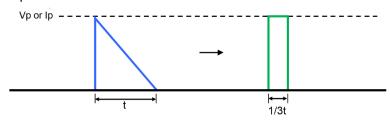
2. Damping oscillation wave with time constant of envelope "t" → Square wave



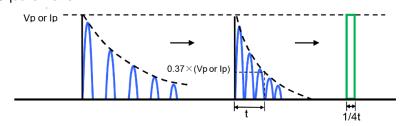
3. Half-wave rectification wave → Square wave



4. Triangular wave → Square wave



5. Special wave → Square wave



Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

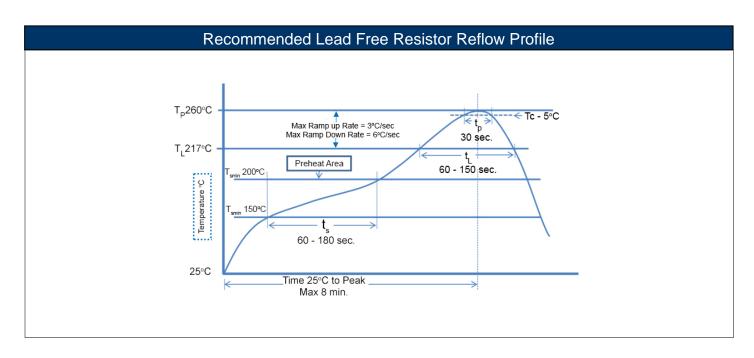
100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

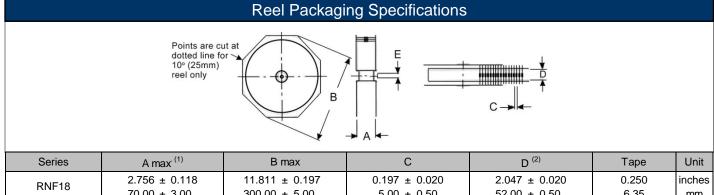
	Wave Soldering					
Description	Maximum	Recommended	Minimum			
Preheat Time	80 seconds	70 seconds	60 seconds			
Temperature Diff.	140°C	120°C	100°C			
Solder Temp.	260°C	250°C	240°C			
Dwell Time at Max.	10 seconds	5 seconds	*			
Ramp DN (°C/sec)	N/A	N/A	N/A			

Temperature Diff. = Defference between final preheat stage and soldering stage.

	Convection IR Reflow					
Description	Maximum	Recommended	Minimum			
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*			
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds			
Solder Temp.	260°C	245°C	*			
Dwell Time at Max.	30 seconds	15 seconds	10 seconds			
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*			



Resistive Product Solutions



Series	A max ⁻⁽¹⁾	B max	С	D ⁽²⁾	Tape	Unit
RNF18	2.756 ± 0.118 70.00 ± 3.00	11.811 ± 0.197 300.00 ± 5.00	0.197 ± 0.020 5.00 ± 0.50	2.047 ± 0.020 52.00 ± 0.50	0.250 6.35	inches
						-
RNMF14	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF14	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
IXIVI 14	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNMF12	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
IXINIVII 12	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF12	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINI 12	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF1	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINFI	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF2	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
MNFZ	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm

Dimension "E": This is a non-critical dimension that does not have a tolerance in the standard.

Range of diameters is from 0.547 inches (13.90 mm) to 1.500 inches (38.10 mm).

- (1) Reference value only. The "A" dimension shall be governed by the overall length of the taped component. The distance between flanges shall be 0.059 inches (1.50 mm) to 0.315 (8.00 mm) greater than the overall component.
- (2) The given dimension "D" expresses the standard width spacing. A 26 mm narrow spacing is available as option "N" packaging code.

Ammo Packaging Specifications Type/Code Size A B C Unit Inches

i ype/Code	Size	A	ם	C	Unit
RNF	16		2.756 ± 0.118 70.00 ± 3.00		inches mm
RNF	14		3.937 ± 0.118 100.00 ± 3.00		inches mm
RNF	12	2.953 ± 0.079 75.00 ± 2.00	2.756 ± 0.118 70.00 ± 3.00	10.039 ± 0.197 255.00 ± 5.00	inches mm
RNF	1		2.953 ± 0.118 75.00 ± 3.00		inches mm
RNMF	14		2.756 ± 0.118 70.00 ± 3.00		inches mm
RNMF	12		3.937 ± 0.118 100.00 ± 3.00		inches mm

Rev Date: 3/3/2022

PRNF14

Symbol

Pana-Sert Packaging Specifications Insulation (0207) *Twisting 0.3mm max W2 H₀ W₁ WO 2±0.5 1.5±0.5 1.6±0.3 ФD0

Description

•	· ·			
ØD	Body diameter	0.102 max.		
	<u> </u>	2.60 max.		
A	Body length	0.276 max.		
		7.00 max. 0.492 max.		
A0	Mounting height	12.50 max.		
		0.020 ± 0.002		
Ød	Lead diameter	0.52 ± 0.05		
Р	Composite to the total t	0.500 ± 0.039		
P	Component pitch	12.70 ± 1.00		
P0	Feed hole pitch	0.500 ± 0.012		
FU	i eed flole pitch	12.70 ± 0.30		
P1	Feed hole center to lead	0.152 ± 0.020		
1 1	r ced fibic center to lead	3.85 ± 0.50		
P2	Feed hole center to body	0.250 ± 0.016		
	. dou note content to body	6.35 ± 0.40		
F	Lead-lead distance	0.200 +0.024 / -0.008		
		5.08 +0.60 / -0.20		
Alpha	Performing angle	45° max.		
Δh	Component alignment	0.000 ± 0.079		
ДП	Component alignment	0.00 ± 2.00		
Δg	Component alignment	0.000 ± 0.118		
<u> </u>	Component alignment	0.00 ± 3.00		
W	Tape width	0.709 +0.039 / -0.031		
		18.00 +1.00 / -0.80		
WO	Hold down tape width	0.492 min.		
		12.50 min. 0.354 ± 0.020		
W1	Hole position			
		9.00 ± 0.50 0.079 +0 / -0.059		
W2	Hold down tape position	2.00 +0 / -1.5		
		0.748 ± 0.039		
Н	Distance to tape center	19.00 ± 1.00		
		0.630 ± 0.020		
H0	Lead wire clinch height	16.00 ± 0.50		
	ı	10.00 ± 0.00		

Resistive Product Solutions

Packaging Specifications – Pana-Sert (cont.)						
Symbol	Description	PRNF14				
I	Lead wire portrait	0.039 max. 1.00 max.				
ØD0	Feed hole diamenter	0.157 ± 0.008 4.00 ± 0.20				
i	Total tape thickness	0.028 max. 0.70 max.				
L	Length of shipped lead	0.433 max. 11.00 max.				

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 2). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament.

	RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01			
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01			

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

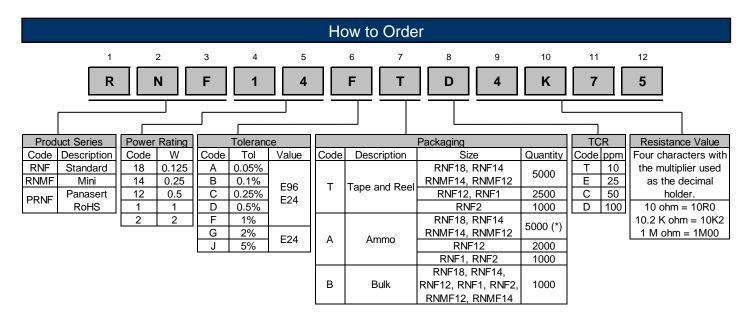
Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

Stackpole Electronics, Inc.

General Purpose Metal Film Resistor

Resistive Product Solutions



(*) Precision metal film resistors with tolerances <1% may be available in smaller quantities. Contact Stackpole for more details.